

WHAT IS CLAIMED IS:

1. A surface emitting semiconductor device comprising:

5 a first conductivity type semiconductor region having a side surface, said first conductivity type semiconductor region being provided on a GaAs semiconductor region;

10 an active layer having a side surface, said active layer being provided on said first conductivity type semiconductor region;

a second conductivity type semiconductor layer, provided on said active layer, having a side surface;

15 a current block semiconductor region provided on said side surface of the first conductivity type semiconductor region, said side surface of said active layer, and said side surface of said second conductivity type semiconductor layer;

20 a first DBR portion having a plurality of first DBR semiconductor layers and a plurality of second DBR semiconductor layers, said first DBR semiconductor layers and said second DBR semiconductor layers being arranged alternately; and

25 a second DBR portion having a plurality of third DBR semiconductor layers and a plurality of fourth DBR semiconductor layers, said third DBR semiconductor layers and said fourth DBR semiconductor layers being

arranged alternately;

wherein said a first conductivity type semiconductor region, said active layer and said second conductivity type semiconductor layer are provided
5 between said first DBR portion and said second DBR portion;

wherein said current block semiconductor region is provided for confining carriers to said first conductivity type semiconductor region, said active
10 layer, and said second conductivity type semiconductor layer; and

wherein said active layer is made of III-V compound semiconductor including at least nitrogen element as a V group member.

15 2. The surface emitting semiconductor device according to claim 1,

wherein III-V compound semiconductor of said active layer contains at least gallium (Ga) as a III group member; and

20 wherein said III-V compound semiconductor of said active layer further contains arsenic (As) as a V group member.

3. The surface emitting semiconductor device according to claim 1,

25 wherein said active layer is made of at least one of GaInNAs semiconductor; GaNAs semiconductor, GaNAsSb

semiconductor, GaNAsP semiconductor, GaNAsSbP semiconductor, GaInNAsSb semiconductor, GaInNAsP semiconductor and GaInNAsSbP semiconductor.

5 4. The surface emitting semiconductor device according to claim 1,

 wherein a refractive index of said second conductivity type semiconductor layer is higher than that of said current block semiconductor region.

10 5. The surface emitting semiconductor device according to claim 1, further comprising an additional semiconductor layer made of III-V compound semiconductor;

15 wherein said additional semiconductor layer is provided between said active layer and said first conductivity type semiconductor region; and

20 wherein a photoluminescence wavelength of said III-V compound semiconductor of said additional semiconductor layer is between that of said active layer and that of said first conductivity type semiconductor region.

 6. The surface emitting semiconductor device according to claim 1, further comprising an additional semiconductor layer made of III-V compound semiconductor;

25 wherein said additional semiconductor layer is provided between said active layer and said second

conductivity type semiconductor layer; and

wherein a photoluminescence wavelength of said
III-V compound semiconductor of said additional
semiconductor layer is between that of said active
5 layer and that of said second conductivity type
semiconductor layer.

7. The surface emitting semiconductor device
according to claim 1, further comprising:

10 a first SCH layer provided between said first
conductivity type semiconductor region and said active
layer; and

a second SCH layer provided between said active
layer and said second conductivity type semiconductor
layer.

15 8. The surface emitting semiconductor device
according to claim 7, further comprising an additional
semiconductor layer made of III-V compound
semiconductor;

20 wherein said additional semiconductor layer is
provided between said first SCH layer and said first
conductivity type semiconductor region; and

25 wherein a photoluminescence wavelength of said
III-V compound semiconductor of said additional
semiconductor layer is between that of said first SCH
layer and that of said first conductivity type
semiconductor layer.

9. The surface emitting semiconductor device according to claim 7, further comprising an additional semiconductor layer made of III-V compound semiconductor;

5 wherein said additional semiconductor layer is provided between said second SCH layer and said second conductivity type semiconductor layer;

wherein a photoluminescence wavelength of said III-V compound semiconductor of said additional
10 semiconductor layer is between that of said second SCH layer and that of said second conductivity type semiconductor layer.

10. The surface emitting semiconductor device according to claim 1,

15 wherein said current block semiconductor region includes first and second current block layers;

wherein said first conductivity type semiconductor region is made of $(\text{Al}_{x_1}\text{Ga}_{1-x_1})_{y_1}\text{In}_{1-y_1}\text{P}$ semiconductor, where a composition x_1 has a value in a
20 range of zero or greater but not greater than 1;

wherein said second conductivity type semiconductor layer is made of $(\text{Al}_{x_2}\text{Ga}_{1-x_2})_{y_2}\text{In}_{1-y_2}\text{P}$ semiconductor, where a composition x_2 has a value in a range of zero or greater but not greater than 1; and

25 wherein said first and second current block layers are made of $(\text{Al}_{x_3}\text{Ga}_{1-x_3})_{y_3}\text{In}_{1-y_3}\text{P}$ semiconductor,

where a composition X3 has a value in a range of zero or greater but not greater than 1.

11. The surface emitting semiconductor device according to claim 1,

5 wherein said current block semiconductor region includes first and second current block layers;

 wherein said first conductivity type semiconductor region is made of an $\text{Al}_{x_1}\text{Ga}_{1-x_1}\text{As}$ semiconductor, where a composition X1 has a value in a
10 range of zero or greater but not greater than 1;

 wherein said second conductivity type semiconductor layer is made of an $\text{Al}_{x_2}\text{Ga}_{1-x_2}\text{As}$ semiconductor, where a composition X2 has a value in a range of zero or greater but not greater than 1; and

15 wherein said first and second current block layers are made of $\text{Al}_{x_3}\text{Ga}_{1-x_3}\text{As}$ semiconductor, where a composition X3 has a value in a range of zero or greater but not greater than 1.

20 12. The surface emitting semiconductor device according to claim 7,

 wherein said first SCH layer is made of one of $\text{Al}_{x_1}\text{Ga}_{1-x_1}\text{As}$ semiconductor ($0 \leq X_1 \leq 1$) and $\text{Ga}_{x_2}\text{In}_{1-x_2}\text{As}_{y_2}\text{P}_{1-y_2}$ semiconductor (about $0.5 \leq X_2 \leq 1$, $0 \leq Y_2 \leq 1$) lattice-matched to GaAs semiconductor; and

25 wherein said second SCH layer is made of one of $\text{Al}_{x_3}\text{Ga}_{1-x_3}\text{As}$ semiconductor ($0 \leq X_3 \leq 1$) and $\text{Ga}_{x_4}\text{In}_{1-x_4}\text{As}_{y_4}\text{P}_{1-y_4}$ semiconductor (about $0.5 \leq X_4 \leq 1$, $0 \leq Y_4 \leq 1$) lattice-matched to GaAs semiconductor.

$x_4\text{As}_{y_4}\text{P}_{1-y_4}$ semiconductor (about $0.5 \leq x_4 \leq 1$, $0 \leq y_4 \leq 1$) lattice-matched to GaAs semiconductor.

13. The surface emitting semiconductor device according to claim 1,

5 wherein said current block semiconductor region includes first and second current block layers; and

 wherein said first and second current block semiconductor layers are made of material not containing aluminum as a III group element.

10 14. The surface emitting semiconductor device according to claim 1,

 wherein said current block semiconductor region comprises first and second current block layers;

 wherein said first and second current block semiconductor layers are made of material not containing aluminum as a III group element;

15 wherein said first conductivity type semiconductor region is made of material not containing aluminum as a III group element; and

20 wherein said second conductivity type semiconductor layer is made of material not containing aluminum as a III group element.

15. The surface emitting semiconductor device according to claim 1,

25 wherein said GaAs semiconductor region is provided by one of a GaAs semiconductor layer and a

gallium arsenide substrate.

16. The surface emitting semiconductor device according to claim 1,

5 wherein said surface emitting semiconductor device is constituted to provide at least one of a semiconductor laser diode and a semiconductor optical amplifier.

17. The surface emitting semiconductor device according to claim 1,

10 wherein said GaAs semiconductor region is provided between said first DBR portion and said active layer.

18. The surface emitting semiconductor device according to claim 1, wherein said second DBR portion
15 is provided between said first DBR portion and said GaAs semiconductor region.

19. A surface emitting semiconductor device comprising:

20 a first conductivity type semiconductor region, provided on a GaAs semiconductor region, including a primary surface having a first area and a second area;

a semiconductor mesa including an active layer and a second conductivity type semiconductor layer, said active layer being provided on said first area of
25 said first conductivity type semiconductor region, said second conductivity type semiconductor layer being

provided on said active layer, and said semiconductor mesa having a side surface;

5 a current block semiconductor region, provided on said second area of said first conductivity type semiconductor region and said side surface of said semiconductor mesa, for confining carriers to said semiconductor mesa;

10 a first DBR portion having a plurality of first DBR semiconductor layers and a plurality of second DBR semiconductor layers, said first DBR semiconductor layers and said second DBR semiconductor layers being arranged alternately; and

15 a second DBR portion having a plurality of third DBR semiconductor layers and a plurality of fourth DBR semiconductor layers, said third DBR semiconductor layers and said fourth DBR semiconductor layers being arranged alternately;

20 wherein said first conductivity type semiconductor region, said active layer and said second conductivity type semiconductor layer are provided between said first DBR portion and said second DBR portion; and

25 wherein said active layer is made of III-V compound semiconductor including at least nitrogen (N) as a V group member.

20. The surface emitting semiconductor device

according to claim 19, wherein said first conductivity type semiconductor region is made of semiconductor material enabling said first conductivity type semiconductor region to be a etch stopper resistant to etchant for etching said active layer and said second conductivity type semiconductor layer.

21. The surface emitting semiconductor device according to claim 19,

wherein III-V compound semiconductor of said active layer contains at least gallium (Ga) as a III group member; and

wherein said III-V compound semiconductor of said active layer contains at least arsenic (As) as a V group member.

22. The surface emitting semiconductor device according to claim 19, wherein said active layer is made of at least one of GaInNAs semiconductor, GaNAs semiconductor, GaNAsSb semiconductor, GaNAsP semiconductor, GaNAsSbP semiconductor, GaInNAsSb semiconductor, GaInNAsP semiconductor and GaInNAsSbP semiconductor.

23. The surface emitting semiconductor device according to claim 19, wherein said second conductivity type semiconductor layer has a refractive index higher than that of said current block semiconductor region.

24. The surface emitting semiconductor device

according to claim 19, further comprising an additional semiconductor layer made of III-V compound semiconductor;

5 wherein said additional semiconductor layer is provided between said first conductivity type semiconductor region and said active layer; and

10 wherein a photoluminescence wavelength of said III-V compound semiconductor of said additional semiconductor layer is between that of said active layer and that of said first conductivity type semiconductor region.

25. The surface emitting semiconductor device according to claim 19, further comprising an additional semiconductor layer made of III-V compound semiconductor;

15 wherein said additional semiconductor layer is provided between said second conductivity type semiconductor layer and said active layer; and

20 wherein a photoluminescence wavelength of said III-V compound semiconductor of said additional semiconductor layer is between that of said active layer and that of said second conductivity type semiconductor layer.

26. The surface emitting semiconductor device according to claim 19, further comprising:

25 a first SCH layer provided between said first

conductivity type semiconductor region and said active layer; and

a second SCH layer provided between said active layer and said second conductivity type semiconductor layer.

27. The surface emitting semiconductor device according to claim 26, further comprising an additional semiconductor layer made of III-V compound semiconductor;

wherein said additional semiconductor layer is provided between said first conductivity type semiconductor region and said first SCH layer; and

wherein a photoluminescence wavelength of said III-V compound semiconductor of said additional semiconductor layer is between that of said first SCH layer and that of said first conductivity type semiconductor layer.

28. The surface emitting semiconductor device according to claim 26, further comprising an additional semiconductor layer made of III-V compound semiconductor;

wherein said additional semiconductor layer is provided between said second conductivity type semiconductor layer and said second SCH layer;

wherein a photoluminescence wavelength of said III-V compound semiconductor of said additional

semiconductor layer is between that of said second SCH layer and that of said second conductivity type semiconductor layer.

29. The surface emitting semiconductor device according to claim 19,

wherein said current block semiconductor region includes first and second current block layers;

wherein said first conductivity type semiconductor region is made of $(Al_{X1}Ga_{1-X1})_{Y1}In_{1-Y1}P$ semiconductor, where a composition $X1$ has a value in a range of zero or greater but not greater than 1;

wherein said second conductivity type semiconductor layer is made of $(Al_{X2}Ga_{1-X2})_{Y2}In_{1-Y2}P$ semiconductor, where a composition $X2$ has a value in a range of zero or greater but not greater than 1; and

wherein said first and second current block layers are made of $(Al_{X3}Ga_{1-X3})_{Y3}In_{1-Y3}P$ semiconductor, where a composition $X3$ has a value in a range of zero or greater but not greater than 1.

30. The surface emitting semiconductor device according to claim 19,

wherein said current block semiconductor region includes first and second current block layers;

wherein said first conductivity type semiconductor region is made of an $Al_{X1}Ga_{1-X1}As$ semiconductor, where a composition $X1$ has a value in a

range of zero or greater but not greater than 1;

wherein said second conductivity type semiconductor layer is made of an $\text{Al}_{x_2}\text{Ga}_{1-x_2}\text{As}$ semiconductor, where a composition x_2 has a value in a range of zero or greater but not greater than 1; and

wherein said first and second current block layers are made of $\text{Al}_{x_3}\text{Ga}_{1-x_3}\text{As}$ semiconductor, where a composition x_3 has a value in a range of zero or greater but not greater than 1.

31. The surface emitting semiconductor device according to claim 26,

wherein said first and second SCH layers is made of one of $\text{Al}_{x_1}\text{Ga}_{1-x_1}\text{As}$ semiconductor ($0 \leq x_1 \leq 1$) and $\text{Ga}_{x_2}\text{In}_{1-x_2}\text{As}_{y_2}\text{P}_{1-y_2}$ semiconductor (about $0.5 \leq x_2 \leq 1$, $0 \leq y_2 \leq 1$) lattice-matched to GaAs semiconductor.

32. The surface emitting semiconductor device according to claim 19,

wherein said current block semiconductor region includes first and second current block layers; and

wherein said first and second current block semiconductor layers are made of material not containing aluminum as a III group element.

33. The surface emitting semiconductor device according to claim 19,

wherein said current block semiconductor region includes first and second current block layers;

wherein said first and second current block semiconductor layers are made of material not containing aluminum as a III group element;

5 wherein said first conductivity type semiconductor region is made of material not containing aluminum as a III group element; and

wherein said second conductivity type semiconductor layer is made of material not containing aluminum as a III group element.

10 34. The surface emitting semiconductor device according to claim 19, wherein said GaAs semiconductor region is provided by one of a GaAs semiconductor layer and a gallium arsenide substrate.

15 35. The surface emitting semiconductor device according to claim 19, wherein said surface emitting semiconductor device is constituted to provide at least one of a semiconductor laser diode and a semiconductor optical amplifier.

20 36. The surface emitting semiconductor device according to claim 19, wherein said GaAs semiconductor region is provided between said first DBR portion and said active layer.

25 37. The surface emitting semiconductor device according to claim 19, wherein said second DBR portion is provided between said first DBR portion and said GaAs semiconductor region.